



30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
	1.7 m Ω @ $V_{GS} = 10$ V	100A
30V	2.8mΩ @ V _{GS} = 4.5V	100A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- Power Management Functions
- DC-DC Converters

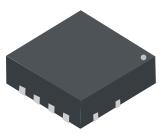
Features and Benefits

- Low R_{DS(ON)} Ensures On-State Losses are Minimized
- Excellent Q_{gd} × R_{DS(ON)} Product (FOM)
- Advanced Technology for DC-DC Converts
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- 100% UIS (Avalanche) Rated
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

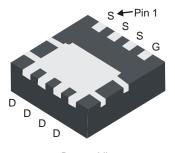
Mechanical Data

- Case: PowerDI[®] 3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminal Finish Matte Tin Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (Approximate)

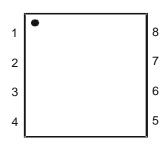
PowerDI3333-8



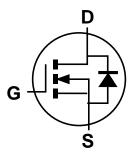




Bottom View



Top View



Equivalent Circuit

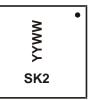
Ordering Information (Note 4)

Part Number	Case	Packaging		
DMT32M5LFG-7	PowerDI3333-8	2,000/Tape & Reel		
DMT32M5LFG-13	PowerDI3333-8	3,000/Tape & Reel		

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



SK2 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 = 2017) WW = Week Code (01 to 53)

Document number: DS39020 Rev. 4 - 2



Maximum Ratings (@ $T_C = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V_{DSS}	30	V	
Gate-Source Voltage	V_{GSS}	±20	V	
Continuous Drain Current (Note 6) $V_{GS} = 10V$ $ T_C = +25^{\circ}C $ $ T_C = +70^{\circ}C $		ΙD	100 100	Α
Continuous Drain Current (Note 5) $V_{GS} = 10V$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		I _D	30 24	Α
Maximum Continuous Body Diode Forward Current (Note 5)	Is	2.8	А	
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)	I _{DM}	350	Α	
Pulsed Body Diode Forward Current (380µs Pulse, Duty Cycle = 1	I _{SM}	350	Α	
Avalanche Current, L = 0.1mH	I _{AS}	46.7	Α	
Avalanche Energy, L = 0.1mH	Eas	109	mJ	

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5) $T_A = +25^{\circ}C$		P_{D}	2.3	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{\theta JA}$	54	°C/W
Total Power Dissipation (Note 6) $T_C = +25^{\circ}C$		P _D	50	W
Thermal Resistance, Junction to Case (Note 6)		$R_{\theta JC}$	2.5	°C/W
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C

Electrical Characteristics (@TJ = +25°C, unless otherwise specified.)

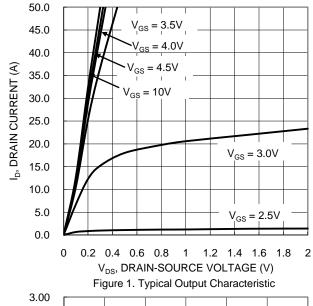
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	I	٧	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}		_	1	μΑ	$V_{DS} = 24V$, $V_{GS} = 0V$	
Zero Gate Voltage Brain Gunerit			_	10		$V_{DS} = 30V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_ _	_	_ ±10	μΑ	$V_{GS} = 20V$, $V_{DS} = 0V$	
<u> </u>	IGSS					$V_{GS} = -16V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	1	1.4	3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
		_	1.4	1.7	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	2.1	2.8		$V_{GS} = 4.5V, I_D = 15A$	
Status Brain Godiso on Nociotarios	1.65(014)	1.9	2.6	mΩ	$V_{GS} = 10V, I_D = 20A,$ $T_J = +125^{\circ}C \text{ (Note 8)}$		
Diode Forward Voltage	V_{SD}	_	0.7	1	V	$V_{GS} = 0V$, $I_S = 2A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	4066	1		V _{DS} = 15V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	1736	l	pF		
Reverse Transfer Capacitance	C_{rss}	_	333	1		1 - 1101112	
Gate Resistance	R_{g}	_	0.71	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g		34	_			
Total Gate Charge (V _{GS} = 10V)	Q_{g}	_	67.7	_	nC	$V_{DS} = 15V, I_D = 20A$	
Gate-Source Charge	Q_{gs}	_	8	-	110		
Gate-Drain Charge	Q_{gd}	_	15	I			
Turn-On Delay Time	t _{D(ON)}	_	7.2	1		$V_{DD} = 15V, V_{GS} = 10V,$ $R_G = 3\Omega, I_D = 20A$	
Turn-On Rise Time	t _R	_	13.2	-	ns		
Turn-Off Delay Time	t _{D(OFF)}		37.4	_	113		
Turn-Off Fall Time	t _F	_	23.9	_			
Bodyy Diode Reverse Recovery Time	t _{RR}	_	28.7	-	ns	I 15A di/dt _ 500A/us	
Body Diode Reverse Recovery Charge	Q_{RR}	_	45.8	_	$_{\rm nC}$ $_{\rm l_F} = 15A$, $_{\rm di/dt} = 500A/\mu s$		

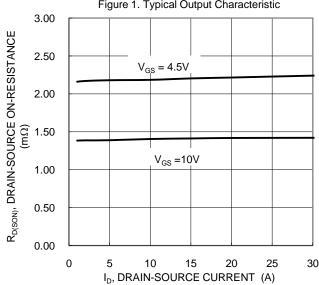
5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. Notes:

6. Thermal resistance from junction to soldering point (on the exposed drain pad).7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.







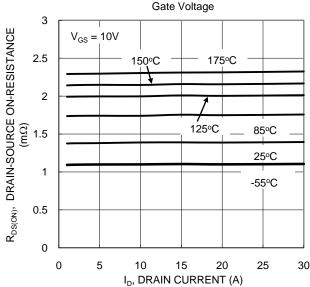
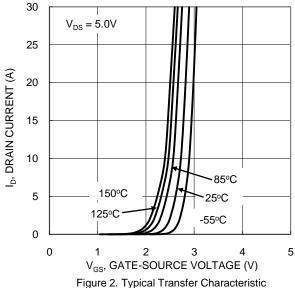
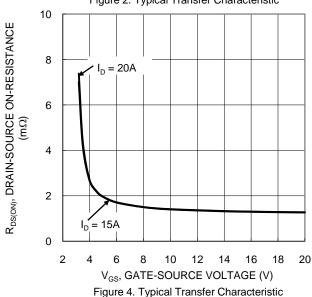


Figure 3. Typical On-Resistance vs. Drain Current and

Figure 5. Typical On-Resistance vs. Drain Current and Temperature





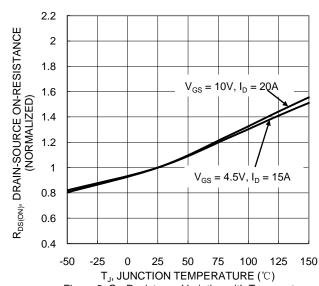
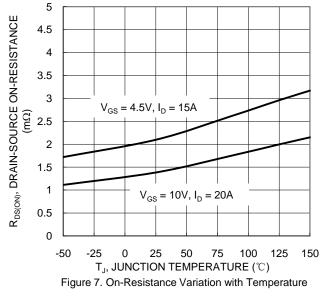


Figure 6. On-Resistance Variation with Temperature







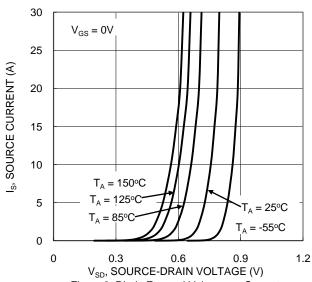
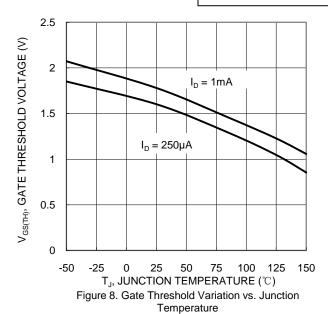
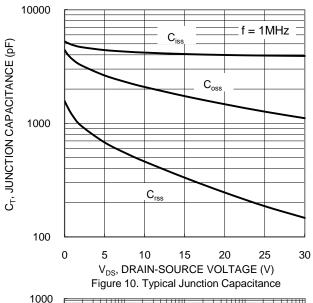
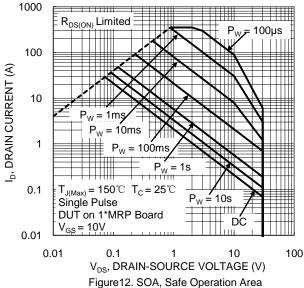


Figure 9. Diode Forward Voltage vs. Current 10 8 6 4 $V_{DS} = 15V, I_{D} = 20A$ 2 0 0 10 20 30 40 50 60 70 Q_q (nC) Figure 11. Gate Charge









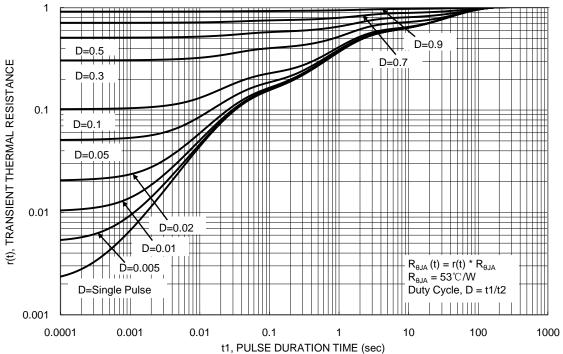


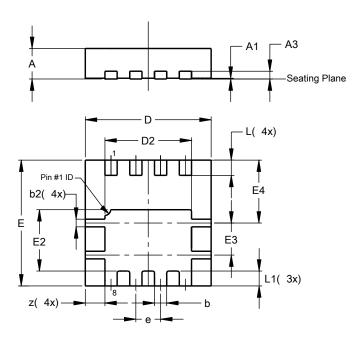
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

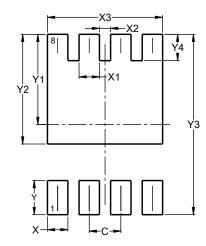


PowerDI3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	_	_	0.203		
b	0.27	0.37	0.32		
b2	0.15	0.25	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
Е	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
E3	0.79	0.89	0.84		
E4	1.60	1.70	1.65		
е	-	-	0.65		
L	0.35	0.45	0.40		
L1	_	_	0.39		
Z	_	_	0.515		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)		
С	0.650		
Х	0.420		
X1	0.420		
X2	0.230		
Х3	2.370		
Υ	0.700		
Y1	1.850		
Y2	2.250		
Y3	3.700		
Υ4	0.540		



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